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Part Number: [87832-3020](#)
Status: **Active**
Overview: [Milli-Grid™ Connector System](#)
Description: 2.00mm Pitch Milli-Grid™ Header, Surface Mount, Vertical, Shrouded, Lead-Free, 30 Circuits, 0.38µm Gold (Au) Plating, with Locking Windows and Centre Polarization Slot, PCB Locator, Tube

Documents:

[3D Model](#) [Product Specification PS-87831-027 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA LR19980
 UL E29179

General

Product Family PCB Headers
 Series [87832](#)
 Application Signal, Wire-to-Board
 Comments Contact Molex for application in automotive industry
 MolexKits Yes
 Overview [Milli-Grid™ Connector System](#)
 Product Name Milli-Grid™
 UPC 822348274543

Physical

Breakaway No
 Circuits (Loaded) 30
 Circuits (maximum) 30
 Color - Resin Black
 Durability (mating cycles max) 100
 First Mate / Last Break No
 Flammability 94V-0
 Glow-Wire Compliant No
 Guide to Mating Part No
 Keying to Mating Part Yes
 Lock to Mating Part Yes
 Material - Metal Phosphor Bronze
 Material - Plating Mating Gold
 Material - Plating Termination Tin
 Material - Resin Nylon
 Net Weight 1.348/g
 Number of Rows 2
 Orientation Vertical
 PCB Locator No
 PCB Retention None
 Packaging Type Tube
 Pitch - Mating Interface 2.00mm
 Pitch - Termination Interface 2.00mm
 Plating min - Mating 0.381µm
 Plating min - Termination 1.905µm
 Polarized to PCB No
 Shrouded Fully
 Stackable No
 Surface Mount Compatible (SMC) Yes
 Temperature Range - Operating -55°C to +105°C



EU RoHS

ELV and RoHS Compliant

REACH SVHC

Not Reviewed

Low-Halogen Status

Not Low-Halogen

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
 For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

[87832Series](#)

Mates With

50394 Wire-to-Board Terminals, 51110 Wire-to-Board Crimp Housing, 87568 Wire-to-Board IDT Housings, 79107 Board-to-Board Top Entry Through Hole Receptacle, 79108 Board-to-Board FFC/FPC Top Entry Through Hole Receptacle, L

Termination Interface: Style Through Hole and Surface Mount

Electrical

Current - Maximum per Contact 2A
Voltage - Maximum 125V

Solder Process Data

Duration at Max. Process Temperature (seconds) 10
Lead-free Process Capability Reflow Capable (SMT only)
Max. Cycles at Max. Process Temperature 1
Process Temperature max. C 260

Material Info

Reference - Drawing Numbers

Product Specification PS-87831-027
Sales Drawing SD-87832-006

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